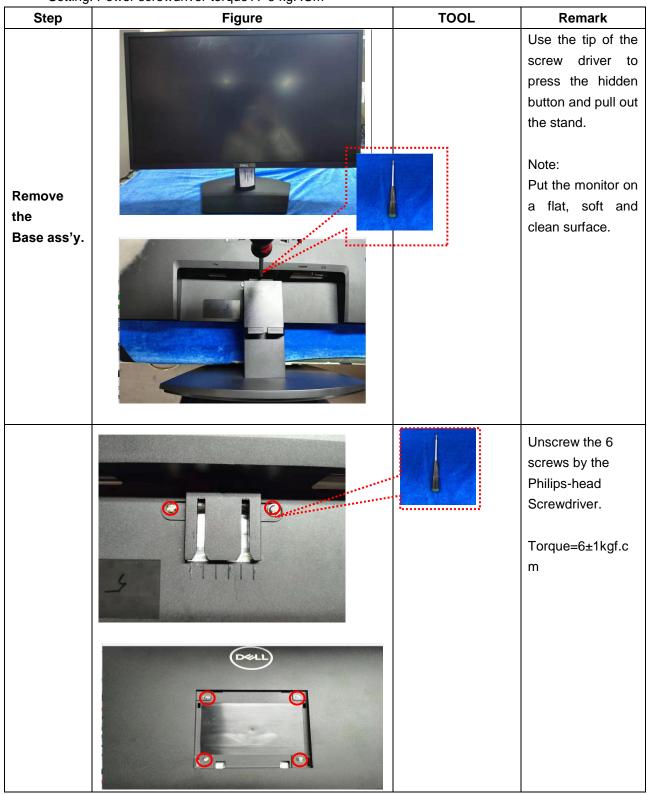
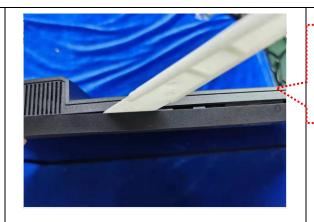
1. Mechanical Instruction

1.1Disassembly Procedures

Tools: 2 Power screwdrivers (ϕ =5mm, L=60mm); 1 small cross screwdriver; turnbuckle driver; Setting: Power screwdriver torque A=6 kgF.Cm



Remove the Rear cover

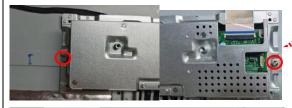


Take scraper insert the bezel bottom site

Disconnect the FFC cables and LVDS cabel.



Tear out all the tapes.
Unscrew the 2 screws on the mainframe.
Torque=6±1kgf.c m
Tear out the wires and mylar.

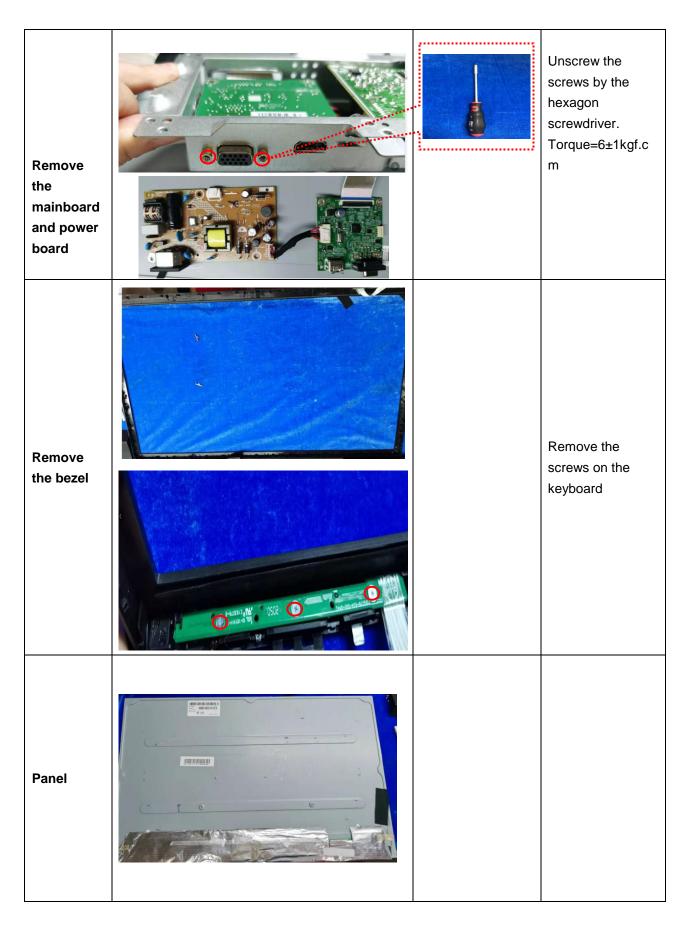








remove the screws on the board by the Philips-head. Torque=6±1kgf.c m



1.2. Product material information

The following substances, preparations, or components should be disposed of or recovered

separately from other WEEE in compliance with Article 4 of EU Council Directive 75/442/EEC.

Capacitors / condensers (containing	No used
PCB/PCT)	
Mercury containing components	No used
Batteries	No used
Printed circuit boards (with a surface	Product has printed circuit boards (with
greater than 10 square cm)	a surface greater than 10 square cm)
Component contain toner, ink and liquids	No used
Plastic containing BFR	No used
Component and waste contain asbestos	No used
CRT	No used
Component contain CFC, HCFC, HFC	No used
and HC	
Gas discharge lamps	No used
LCD display > 100 cm2	Product has an LCD greater than 100
	cm2
External electric cable	Product has external cables
Component contain refractory ceramic	No used
fibers	
Component contain radio-active	No used
substances	
Electrolyte capacitors (height	Product has electrolyte capacitors
> 25mm, diameter > 25mm)	(height > 25mm, diameter > 25mm)

1.3. Tools Required

List the type and size of the tools that would typically can be used to disassemble the product to a point

where components and materials requiring selective treatment can be removed.

Tool Description:

- Screwdriver (Phillip-head, Hexagonal head)
- Penknife
- Soldering iron and absorber